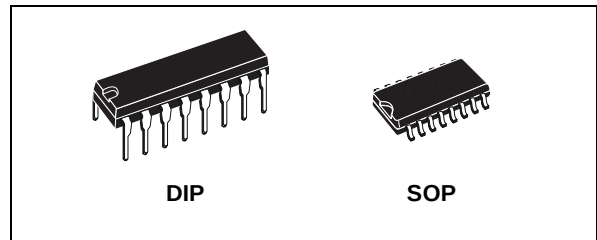




HCF4033B

DECADE COUNTER/DIVIDER WITH DECODED 7-SEGMENT DISPLAY OUTPUT AND RIPPLE BLANKING

- COUNTER AND 7-SEGMENT DECODING IN ONE PACKAGE
- EASILY INTERFACED WITH 7-SEGMENT DISPLAY TYPES
- FULLY STATIC COUNTER OPERATION : DC TO 6MHz (Typ.) AT $V_{DD} = 10V$
- IDEAL FOR LOW POWER DISPLAYS
- RIPPLE BLANKING AND LAMP TEST
- QUIESCENT CURRENT SPECIF. UP TO 20V
- STANDARDIZED SYMMETRICAL OUTPUT CHARACTERISTICS
- INPUT LEAKAGE CURRENT
 $I_l = 100nA$ (MAX) AT $V_{DD} = 18V$ $T_A = 25^\circ C$
- 100% TESTED FOR QUIESCENT CURRENT
- MEETS ALL REQUIREMENTS OF JEDEC JESD13B " STANDARD SPECIFICATIONS FOR DESCRIPTION OF B SERIES CMOS DEVICES"



ORDER CODES

PACKAGE	TUBE	T & R
DIP	HCF4033BEY	
SOP	HCF4033BM1	HCF4033M013TR

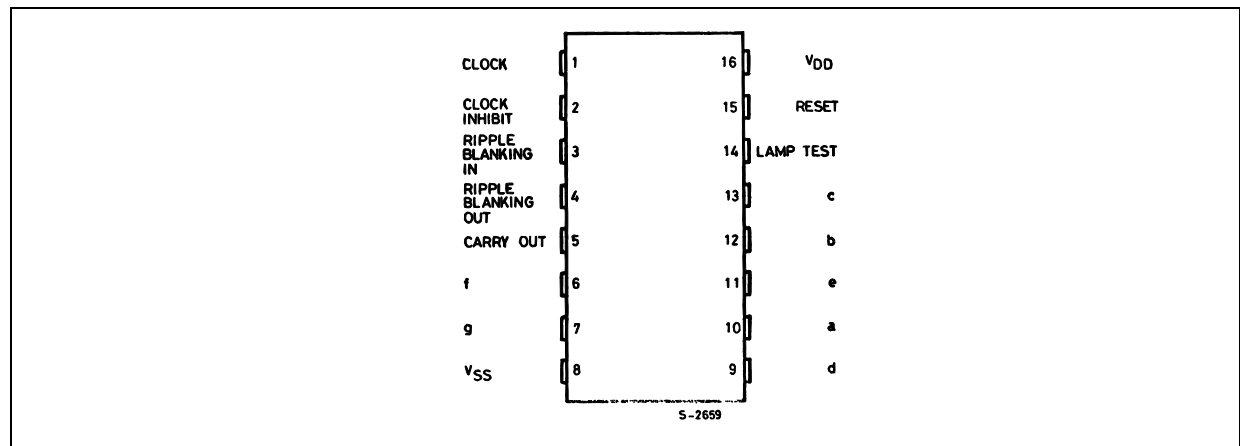
DESCRIPTION

The HCF4033B is a monolithic integrated circuit fabricated in Metal Oxide Semiconductor technology available in DIP and SOP packages. The HCF4033B consists of a 5-stages Johnson decade counter and an output decoder which converts the Johnson code to a 7 segment decoded output for driving one stage in a numerical display. This device is particularly advantageous in display applications where low power dissipation and/or low package count are

important. This device has CLOCK, RESET, CLOCK INHIBIT, RIPPLE BLANKING, LAMP TEST input, CARRY OUT, RIPPLE BLANKING and 7 DECODED outputs (a to g).

A high RESET signal clears the decade counter to its zero count. The counter is advanced one count at the positive clock signal transition if the CLOCK INHIBIT signal is low. Counter advancement via the clock line is inhibited when the CLOCK INHIBIT signal is high. Antilock gating is provided on the JOHNSON counter, thus assuring proper counting sequence. The CARRY-OUT (C_{OUT}) signal completes one cycle every ten CLOCK INPUT cycles and is used to clock the succeeding decade directly in a multi-decade counting chain.

PIN CONNECTION

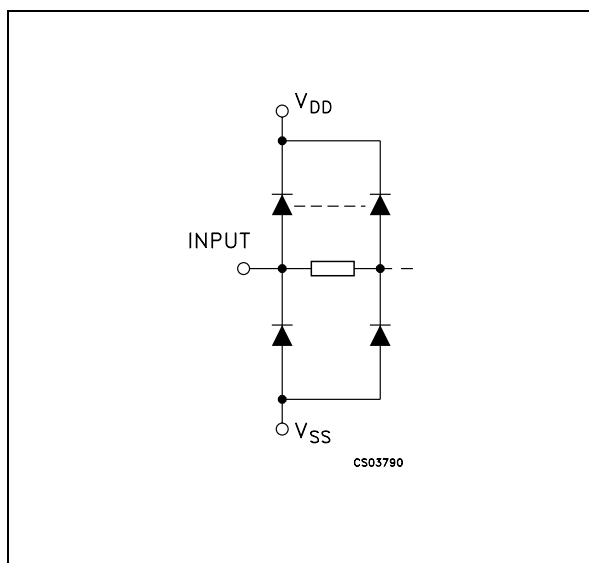


HCF4033B

The seven decoded outputs (a, b, c, d, e, f, g) illuminate the proper segments in a seven segment display device used for representing the decimal numbers 0 to 9. The 7-segment outputs go high on selection. This device has provisions for automating blanking of the non-significant zeros in a multi digit decimal number which results in a easily readable display consistent with normal writing practice. For example, the number 0050.07000 in an eight digit display would be displayed as 50.07. Zero suppression on the integer side is obtained by connecting the RBI terminal of the HCF4033B associated with the most significant digit in the display to a low level voltage and connecting the RBO terminal of that stage to the RBI terminal of the HCF4033B in the next lower significant position in the display. This procedure is continued for each succeeding HCF4033B on the integer side of the display. On the fraction side of the display the RBI of the

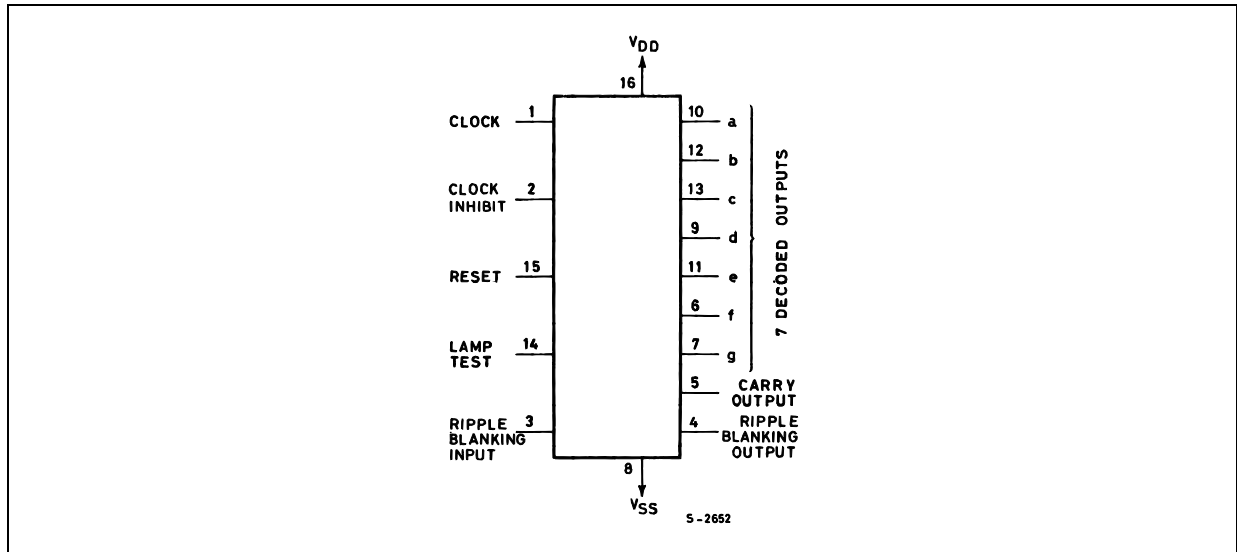
HCF4033B associated with the least significant bit is connected to a low level voltage and the RBO of that HCF4033B is connected to the RBI terminal of the HCF4033B in the next more significant bit position. Again, this procedure is continued for all HCF4033B's on the fraction side of the display. In a purely fractional number the zero immediately preceding the decimal point can be displayed by connecting the RBI of that stage to a high level voltage (instead of to the RBO of the next more significant stage). For example : optional zero → 0.7346. Likewise, the zero in a number such as 763.0 can be displayed by connecting the RBI of the HCF4033B associated with it to a high level voltage. Ripple blanking of non-significant zeros provides an appreciable savings in display power. The HCF4033B has a LAMP TEST input which, when connected to a high level voltage, overrides normal decoder operation and enables a check to be made on possible display malfunctions by putting the seven outputs in the high state.

PIN DESCRIPTION

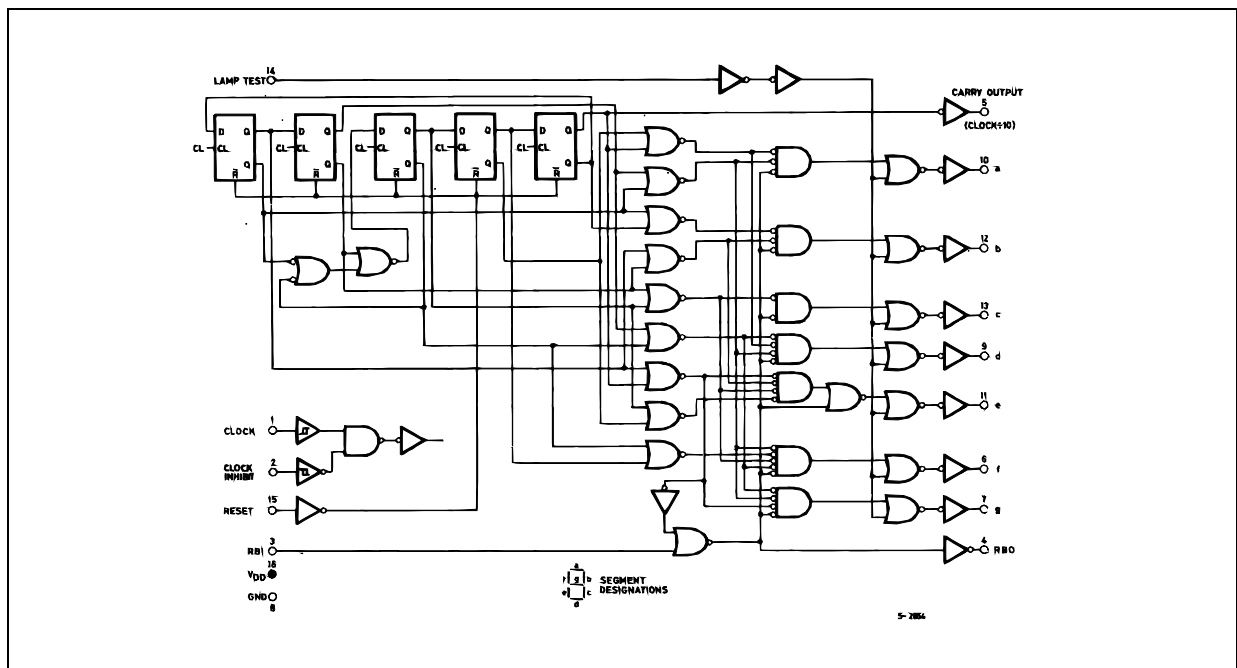


PIN No	SYMBOL	NAME AND FUNCTION
1	CLOCK	Clock Input
10, 12, 13, 9, 11, 6, 7	a to g	7 - Segments Decoded Outputs
2	CLOCK INHIBIT	Clock Inhibit Input
15	RESET	Reset Input
3	RIPPLE BLANKING IN	Ripple Blanking Input
5	CARRY OUT	Carry Out Output
4	RIPPLE BLANKING OUT	Ripple Blanking Output
14	LAMP TEST	Lamp Test Input
8	V_{SS}	Negative Supply Voltage
16	V_{DD}	Positive Supply Voltage

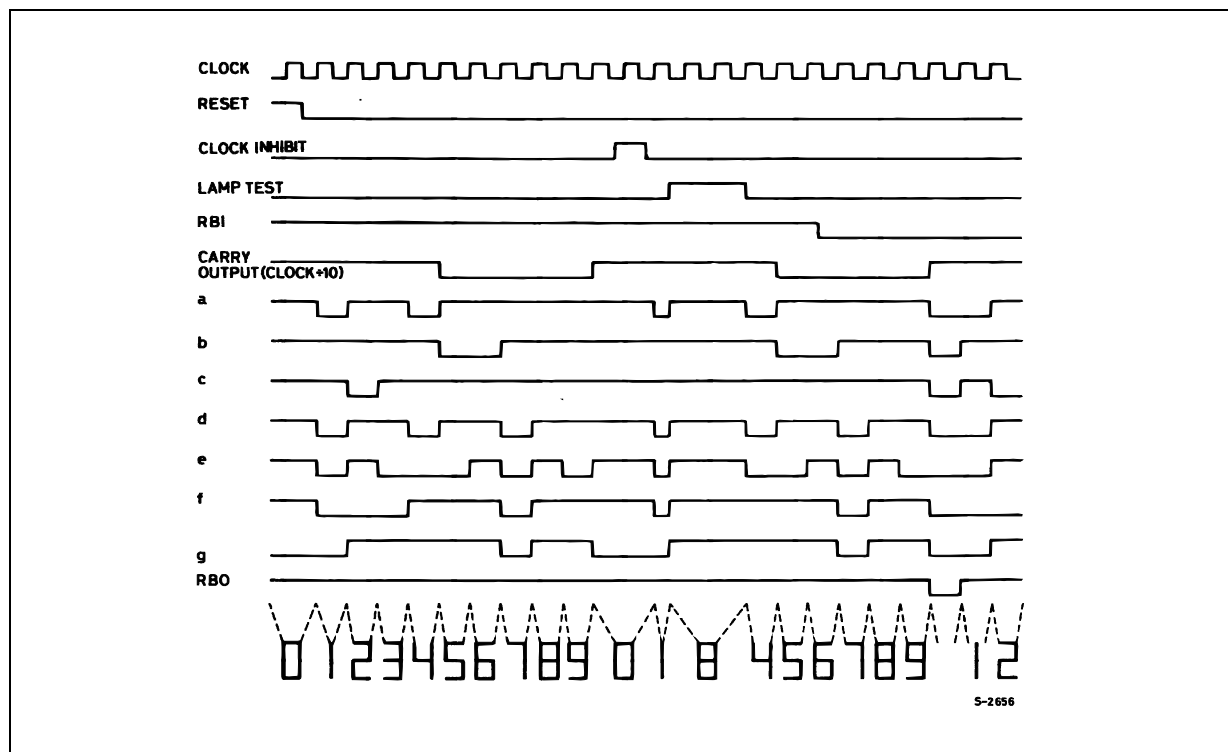
FUNCTIONAL DIAGRAM



LOGIC DIAGRAM



TIMING CHART



ABSOLUTE MAXIMUM RATINGS

Symbol	Parameter	Value	Unit
V_{DD}	Supply Voltage	-0.5 to +22	V
V_I	DC Input Voltage	-0.5 to $V_{DD} + 0.5$	V
I_I	DC Input Current	± 10	mA
P_D	Power Dissipation per Package	200	mW
	Power Dissipation per Output Transistor	100	mW
T_{op}	Operating Temperature	-55 to +125	°C
T_{stg}	Storage Temperature	-65 to +150	°C

Absolute Maximum Ratings are those values beyond which damage to the device may occur. Functional operation under these conditions is not implied.

All voltage values are referred to V_{SS} pin voltage.

RECOMMENDED OPERATING CONDITIONS

Symbol	Parameter	Value	Unit
V_{DD}	Supply Voltage	3 to 20	V
V_I	Input Voltage	0 to V_{DD}	V
T_{op}	Operating Temperature	-55 to 125	°C

DC SPECIFICATIONS

Symbol	Parameter	Test Conditions				Value								Unit
		V _I (V)	V _O (V)	I _O (μA)	V _{DD} (V)	T _A = 25°C			-40 to 85°C		-55 to 125°C			
						Min.	Typ.	Max.	Min.	Max.	Min.	Max.		
I _L	Quiescent Current	0/5			5		0.04	5		150		150	μA	
		0/10			10		0.04	10		300		300		
		0/15			15		0.04	20		600		600		
		0/20			20		0.08	100		3000		3000		
V _{OH}	High Level Output Voltage	0/5		<1	5	4.95			4.95		4.95		V	
		0/10		<1	10	9.95			9.95		9.95			
		0/15		<1	15	14.95			14.95		14.95			
V _{OL}	Low Level Output Voltage	5/0		<1	5		0.05			0.05		0.05	V	
		10/0		<1	10		0.05			0.05		0.05		
		15/0		<1	15		0.05			0.05		0.05		
V _{IH}	High Level Input Voltage		0.5/4.5	<1	5	3.5			3.5		3.5		V	
			1/9	<1	10	7			7		7			
			1.5/18.5	<1	15	11			11		11			
V _{IL}	Low Level Input Voltage		0.5/4.5	<1	5			1.5		1.5		1.5	V	
			9/1	<1	10			3		3		3		
			1.5/18.5	<1	15			4		4		4		
I _{OH}	Output Drive Current	0/5	2.5		5	-1.36	-3.2		-1.1		-1.1		mA	
		0/5	4.6		5	-0.44	-1		-0.36		-0.36			
		0/10	9.5		10	-1.1	-2.6		-0.9		-0.9			
		0/15	13.5		15	-3.0	-6.8		-2.4		-2.4			
I _{OL}	Output Sink Current	0/5	0.4		5	0.44	1		0.36		0.36		mA	
		0/10	0.5		10	1.1	2.6		0.9		0.9			
		0/15	1.5		15	3.0	6.8		2.4		2.4			
I _I	Input Leakage Current	0/18	any input		18		±10 ⁻⁵	±0.1		±1		±1	μA	
C _I	Input Capacitance		any input				5	7.5					pF	

The Noise Margin for both "1" and "0" level is: 1V min. with V_{DD}=5V, 2V min. with V_{DD}=10V, 2.5V min. with V_{DD}=15V

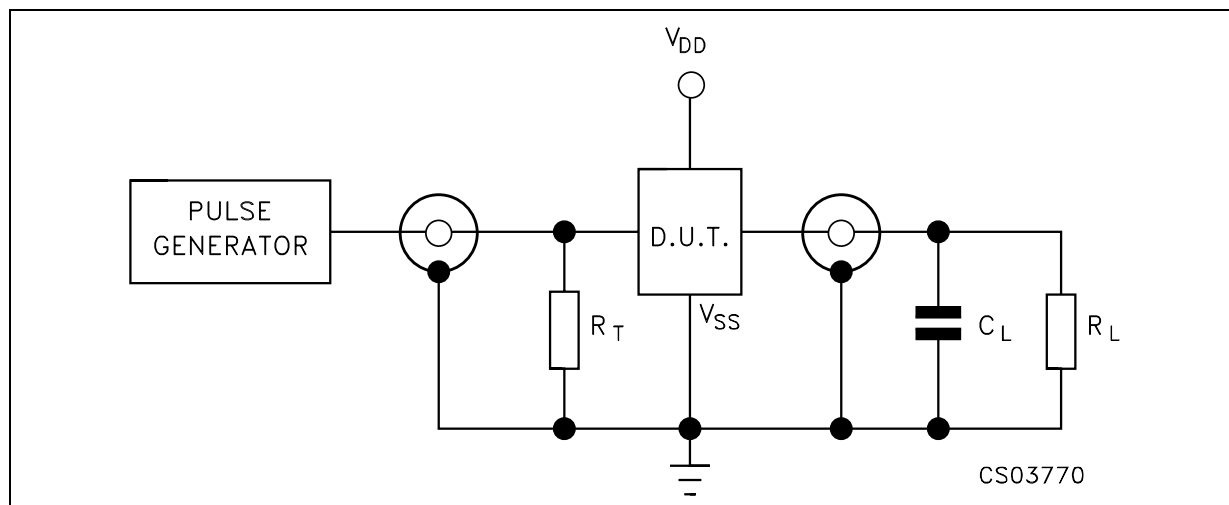
DYNAMIC ELECTRICAL CHARACTERISTICS ($T_{amb} = 25^{\circ}\text{C}$, $C_L = 50\text{pF}$, $R_L = 200\text{K}\Omega$, $t_r = t_f = 20\text{ ns}$)

Symbol	Parameter	Test Condition		Value (*)			Unit
		V _{DD} (V)		Min.	Typ.	Max.	
CLOCKED OPERATION							
t _{PLH} t _{PHL}	Propagation Delay Time (Carry Out Line)	5			250	500	ns
		10			100	200	
		15			75	150	
t _{PLH} t _{PHL}	Propagation Delay Time (Decoded Out Lines)	5			350	700	ns
		10			125	250	
		15			90	180	
t _{THL} t _{TLH}	Transition Time (Carry Out Line)	5			100	200	ns
		10			50	100	
		15			25	50	
f _{CL} ⁽¹⁾	Maximum Clock Input Frequency	5		2.5	5		MHz
		10		5.5	11		
		15		8	16		
t _{WC}	Clock Pulse Width	5			110	260	ns
		10			50	100	
		15			40	80	
t _r , t _f	Clock Input Rise or Fall Time	5		Unlimited			μs
		10					
		15					
RESET OPERATION							
t _{PLH} t _{PHL}	Propagation Delay Time (Carry Out Line)	5			275	550	ns
		10			120	240	
		15			80	160	
t _{PLH} t _{PHL}	Propagation Delay Time (Decoded Out Lines)	5			300	600	ns
		10			125	250	
		15			90	180	
t _{WR}	Reset Pulse Widht	5			100	120	ns
		10			50	100	
		15			25	50	
t _{rem}	Reset Removal Time	5			0	30	ns
		10			0	15	
		15			0	10	

(*) Typical temperature coefficient for all V_{DD} value is 0.3 %/°C.

(1) Measured with respect to carry output line.

TEST CIRCUIT



C_L = 50pF or equivalent (includes jig and probe capacitance)

R_L = 200K Ω

R_T = Z_{OUT} of pulse generator (typically 50 Ω)

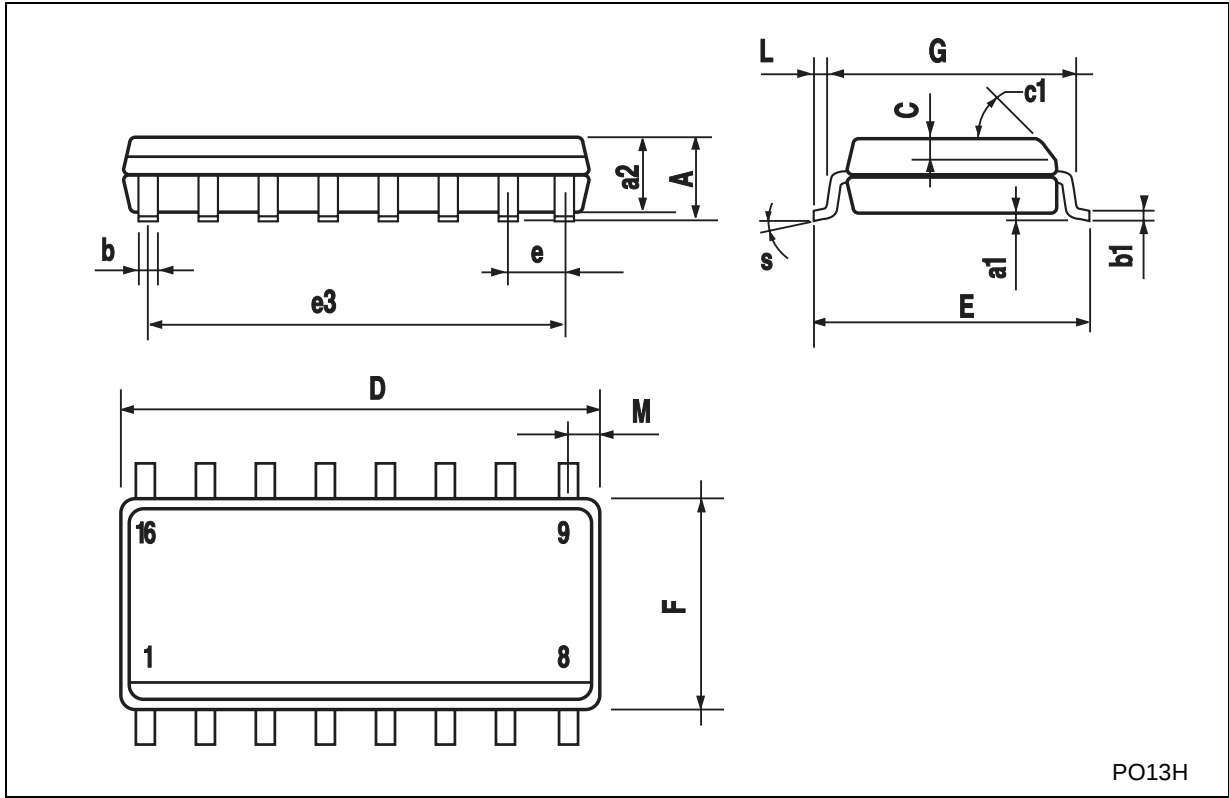
Plastic DIP-16 (0.25) MECHANICAL DATA

DIM.	mm.			inch		
	MIN.	TYP	MAX.	MIN.	TYP.	MAX.
a1	0.51			0.020		
B	0.77		1.65	0.030		0.065
b		0.5			0.020	
b1		0.25			0.010	
D			20			0.787
E		8.5			0.335	
e		2.54			0.100	
e3		17.78			0.700	
F			7.1			0.280
I			5.1			0.201
L		3.3			0.130	
Z			1.27			0.050



SO-16 MECHANICAL DATA

DIM.	mm.			inch		
	MIN.	TYP	MAX.	MIN.	TYP.	MAX.
A			1.75			0.068
a1	0.1		0.2	0.003		0.007
a2			1.65			0.064
b	0.35		0.46	0.013		0.018
b1	0.19		0.25	0.007		0.010
C		0.5			0.019	
c1	45° (typ.)					
D	9.8		10	0.385		0.393
E	5.8		6.2	0.228		0.244
e		1.27			0.050	
e3		8.89			0.350	
F	3.8		4.0	0.149		0.157
G	4.6		5.3	0.181		0.208
L	0.5		1.27	0.019		0.050
M			0.62			0.024
S	8° (max.)					



PO13H



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